

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application No. : 10/762,807  
Applicant : Amitay Levi  
  
Filed : January 21, 2004  
TC/A.U. : 2818  
Examiner : Calvin Lee  
Title : **METHOD OF PLANARIZING A SEMICONDUCTOR DIE**  
Docket No. : 2102397-992432  
Customer No. : 26379

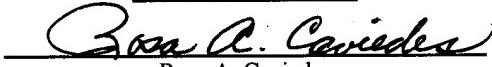
**M/S AMENDMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

**Certificate of Mailing**

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as FIRST CLASS MAIL in an envelope addressed to: Mail Stop AMENDMENT, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on:

June 10, 2005

  
Rosa A. Caviedes

**RESPONSE TO OFFICE ACTION OF MAY 17, 2005**

Sir:

In response to the Office Action of May 17, 2005, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 5 of this paper.